

Bi-directional Ultra Low Capacitance ESD Protection Diode

DESCRIPTIONS

The TESDH5V0B05P1Q1 is an ultra-low capacitance TVS (Transient Voltage Suppressor) designed to protect high speed data interfaces. It has been specifically designed to protect sensitive electronic components which are connected to data and transmission lines from over-voltage damage by Electrostatic Discharging (ESD).

TESDH5V0B05P1Q1 incorporates one pair of ultralow capacitance steering diodes plus a TVS diode. During transient conditions, the steering diodes direct the transient to either the internal ESD line. The internal unique design of clamping cell prevents overvoltage on the data and I/O lines, protecting any downstream components.

The TESDH5V0B05P1Q1 may be used to provide ESD protection up to $\pm 20 kV$ (contact and air discharge) according to IEC61000-4-2, and withstand peak pulse current up to 5.5A (8/20 μ s) according to IEC61000-4-5.

FEATURES

- ESD protect for 1 line with bidirectional
- Provide ESD protection for each channel to IEC61000-4-2 (ESD) ±20kV (air), ±20kV (contact) IEC61000-4-5 (Lightning) 5.5A (8/20µs)
- Protect one I/O line
- Fast turn-on and Low clamping voltage
- Solid-state silicon-avalanche and active circuit triggering technology
- Suitable for 5V and below, operating voltage applications
- Ultra-low capacitance: C_J = 0.40pF(typ.)
- Ultra-low leakage current: I_R = 2nA(typ.)
- Low clamping voltage: Vcl = 9.8V(typ.) @ ITLP = 16A
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-Free according to IEC61249-2-21

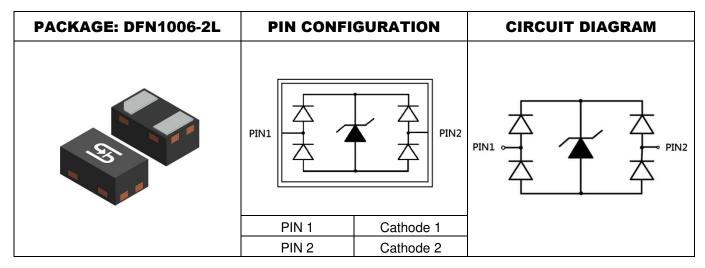
APPLICATION

- USB 2.0 and USB 3.0
- HDMI 1.3 and HDMI 1.4
- SATA and eSATA
- DVI
- IEEE 1394
- PCI Express
- Portable Electronics
- Notebooks





HALOGEN FRFF



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ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	VALUE	UNIT	
Peak pulse power (tp = 8/20us)	P _{PK}	46	W	
Peak pulse current (tp = 8/20us)	I _{PP}	5.5	А	
ESD according to IEC61000-4-2 air discharge	V	±20	kV	
ESD according to IEC61000-4-2 contact discharge	V _{ESD}	±20	kV	
Junction temperature	T_J	125	°C	
Operating temperature range	T _{OP}	-40 to +85	°C	
Storage temperature range	T _{STG}	-55 to +150	°C	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)							
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT	
Reverse working voltage		V_{RWM}	-	-	5	٧	
Reverse breakdown voltage	$I_R = 1 \text{mA}, T_J = 25^{\circ}\text{C}$	$I_R = 1 \text{mA}, T_J = 25 ^{\circ}\text{C}$ V_{BR}		-	12.5	٧	
Reverse leakage current	$V_{RWM} = 5V$	I _R	-	2	50	nA	
(1)	$I_{PP} = 1.0A$, $tp = 8/20us$	V _C	-	-	5.5	٧	
Clamping voltage ⁽¹⁾	$I_{PP} = 5.5A$, $tp = 8/20us$		V _C	us V _C	-	-	8.5
Clamping voltage ⁽²⁾	$I_{TLP} = 16A, tp = 100ns$	V _{CL}	-	9.8	-	V	
Junction capacitance	f = 1MHz, V _R = 0V	CJ	-	0.4	0.5	pF	
Dynamic resistance ⁽²⁾		R _{DYN}	-	0.37	-	Ω	

Notes:

- 1. Non-repetitive current pulse, according to IEC61000-4-5.
- 2. TLP parameter: Z_0 = 50 Ω , tp = 100ns, tr = 2ns, averaging window from 60ns to 80ns. RDYN is calculated from 4A to 16A.

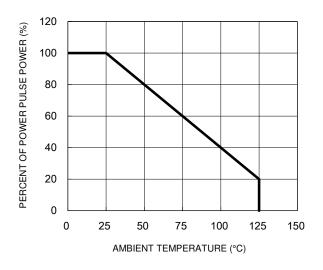
ORDERING INFORMATION				
ORDERING CODE	PACKAGE	PACKING		
TESDH5V0B05P1Q1 M5G	DFN1006-2L	10,000 / 7" Tape & Reel		



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Peak Pulse Power vs. Junction Temperature Fig.2 Non-Repetitive Peak Pulse Power vs. Pulse Time



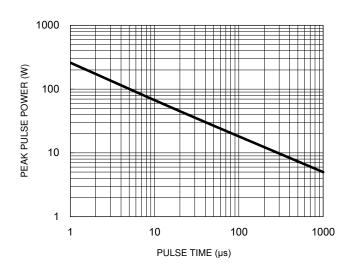
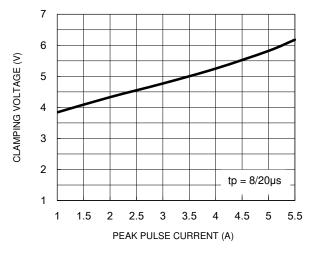


Fig.3 Clamping Voltage vs. Peak Pulse Current

Fig.4 Capacitance vs. Reverse Voltage



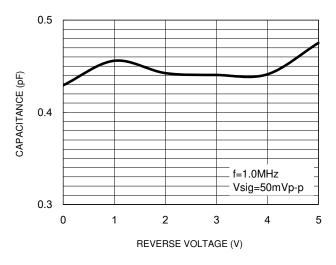
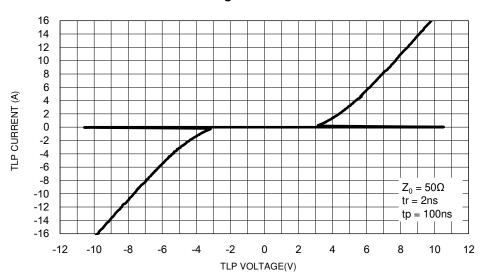


Fig.5 TLP Curve





CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.6 8/20µs pulse waveform per IEC61000-4-5

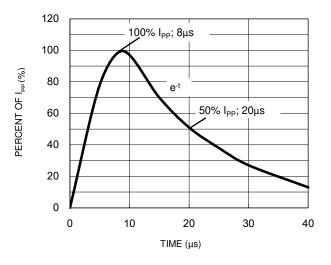
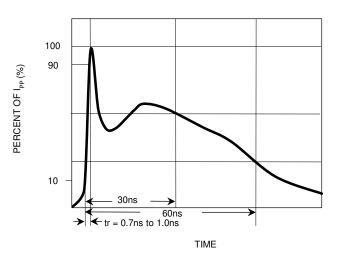


Fig.7 ESD pulse waveform per IEC61000-4-2



Version: A2203

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APPLICATION INFORMATION

Device Connection

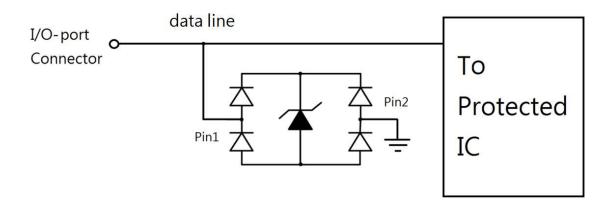
The TESDH5V0B05P1Q1 is designed to protect one data lines from transient over-voltage (such as ESD stress pulse). It provides bidirectional protection.

In order to obtain enough suppression of ESD induced transient, good circuit board is critical. Thus, the following guidelines are recommended:

- Let the path length between the protected lines and the TESDH5V0B05P1Q1 minimize.
- Place the TESDH5V0B05P1Q1 near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- · Use ground planes whenever possible.

The Fig.1 below shown the onnection for data line ESD protection

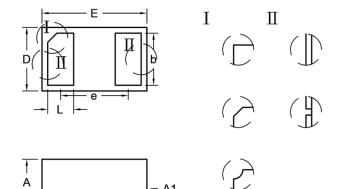
Fig.1 ESD protection by TESDH5V0B05P1Q1





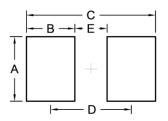
PACKAGE OUTLINE DIMENSIONS

DFN1006-2L



DIM.	Unit (mm)		Unit (inch)		
Dilvi.	Min.	Max.	Min.	Max.	
А	0.34	0.53	0.013	0.021	
A1	0.00	0.05	0.000	0.002	
b	0.45	0.55	0.018	0.022	
D	0.55	0.675	0.022	0.027	
E	0.95	1.075	0.037	0.042	
е	0.65		0.026		
L	0.20	0.30	0.008	0.012	

SUGGESTED PAD LAYOUT

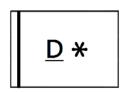


Symbol	Unit (mm)	Unit (inch)
Α	0.60	0.024
В	0.45	0.018
С	1.20	0.047
D	0.75	0.030
E	0.30	0.012

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.

MARKING DIAGRAM



= Device Code <u>D</u>

= Month Code (A - Z)



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